

01-22-2003

EET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

Tab settings → → → ▼ ▼ ▼

To the Honorable Commissioner of Pat.

102343470

Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hideyuki Ikeda
Yuki Nakano

1-16-03

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other

Execution Date: November 7, 2002

2. Name and address of receiving party(ies):

Name: Horiba, Ltd.

Address: 2, Miyanohigashi-cho, Kisshoin

City: Minami-ku

State/Prov.: Kyoto

Country: Japan

ZIP:

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.

Filing date

B. Patent No.(s)

10/289,906

November 7, 2002

Additional numbers

☐ Yes ☐ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Joseph W. Price

Registration No. 25,126

Address: SNELL & WILMER, LLP

1920 Main Street, Suite 1200

01/21/2003 TDI A21 00000009 192814 10289906

01 FC:0021 40.00 CH

City: Irvine State/Prov.: CA

Country: U.S.A. ZIP: 92614-7230

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

8. Deposit account number:

19-2814

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph W. Price

Name of Person Signing

Signature

January 10, 2003

Date

3

Total number of pages including cover sheet, attachments, and

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231PATENT
REEL: 013666 FRAME: 0245

ASSIGNMENT

WHEREAS, I/we, Hideyuki IKEDA and Yuki NAKANO

(hereinafter "Assignor(s)"), citizen(s) of Japan, have invented certain new and useful improvements in a PARTICLE DIAMETER DISTRIBUTION MEASUREMENT APPARATUS AND METHOD OF CALIBRATION for which I/we have executed application for Letters Patent of the United States, filed November 7, 2002 and given serial no. 10/289,906; and

WHEREAS, HORIBA, Ltd. hereinafter "Assignee"), a corporation of Japan, having a principal place of business at 2, Miyano Higashi-cho, Kisshoin, Minami-ku, Kyoto, Japan is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application,

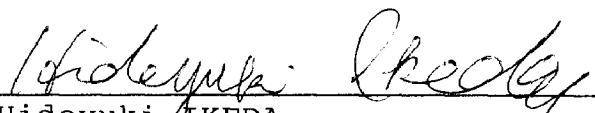
NOW, THEREFORE, in consideration of the sum of One Hundred Yen (¥100) to me/us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the Assignor(s) have sold, assigned, transferred and set over, unto said Assignee, its successors, legal representatives and assigns, the entire right, title and interest in, to and under said improvements, and said application and all divisions, renewals and continuations thereof, and all Letters Patents of the United States, which may be granted thereon and all reissues and extensions thereof, and all priority rights under the International Convention for the Protection of Industrial Property for every country of the Union, and all applications for Letters Patents which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patents which may be granted for said improvements in any country or countries foreign to the United States, and any official of any country or countries foreign to the United States, whose duty it is to issue patents, on applications as aforesaid, to issue all Letters Patents for said improvements to said Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I/WE, HEREBY covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed, and will not execute, any agreement in conflict herewith.


AND I/WE HEREBY further covenant and agree that I/we will communicate to said Assignee, its successors, legal representatives and assigns, any facts known to me/us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything

possible to aid said Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand this 7th
day of November, 2002 .


Hideyuki IKEDA

IN TESTIMONY WHEREOF, I hereunto set my hand this 7th
day of November, 2002 .


YUKI NAKANO